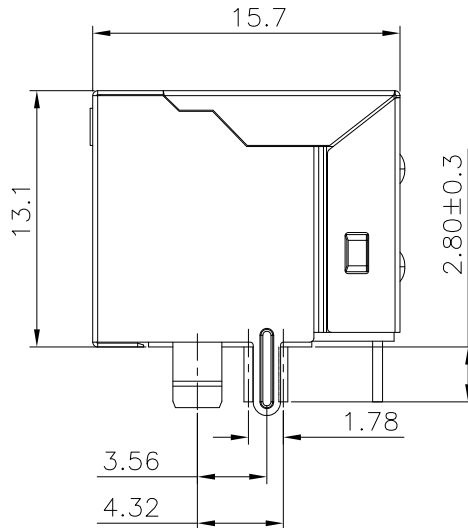
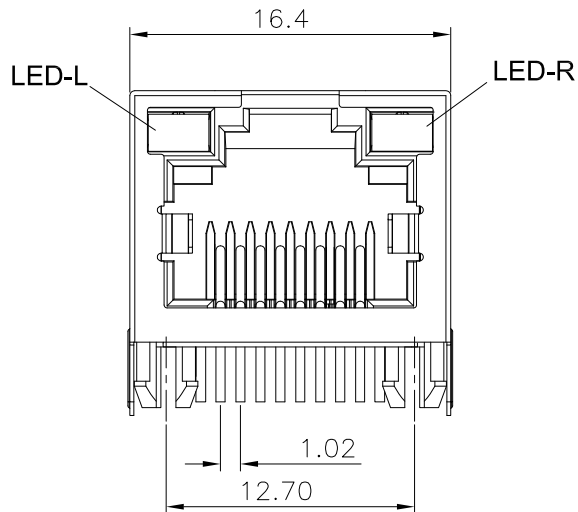
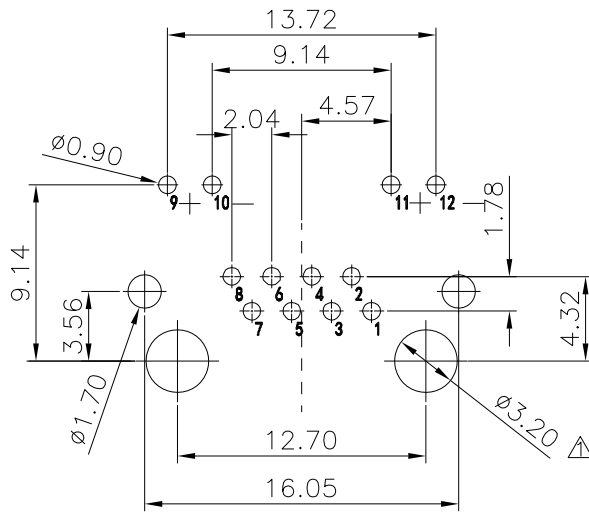
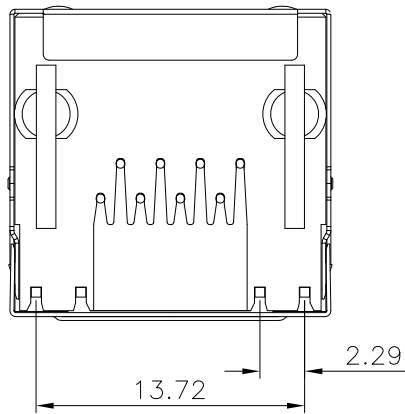


The product using material and processing must conform to the "WI-PZ-001"HSF technical standard control requirements



NOTE:
 1.MATERIAL SPECIFICATION:
 1-1.HOUSING: PBT UL94V-0, BLACK
 1-2.SHELL: 0.20mm THICKNESS COPPER ALLOY
 1-3.CONTACT: PHOSPHOR BRONZE ϕ 0.46mm
 2.PLATING SPECIFICATION:
 2-1.SHELL:
 NICKEL UNDER PLATED OVER ALL
 2-2.CONTACTS:
 GOLD FLASH PLATING OVER NICKEL
 3.MECHANICAL PERFORMANCE:
 3-1.INSERTION FORCE: 22N MAX
 3-2.REMOVAL FORCE: 22N MAX
 3-2.DURABILITY: 750 CYCLES MIN.
 4.ELECTRICAL PERFORMANCE:
 4-1.CURRENT RATING:1.5A
 4-2.VOLTAGE RATING:125V MAX
 4-3.CONTACT RESISTANCE: 40m Ω Max.
 4-4.INSULATION RESISTANCE: 500M Ω MIN
 4-5.DIELECTRIC WITHSTANDING VOLTAGE: 500V AC Min
 5.ENVIRONMENTAL PERFORMANCE:
 OPERATING TEMPERATURE: -40°C~+85°C.
 6.PACKAGE SPEC:TRAY



PCBLAYOUT
TOL:±0.05

P/N:
WLR4F9-08 1 X X X 037

PLATING:
 1-G/F
 2-Au 3u"
 3-Au 6u"
 5-Au 15u"
 6-Au 30u"
 LED:
 1-LEFT:YELLOW
 RIGHT:GREEN
 2-LEFT:GREEN
 RIGHT:YELLOW
 COLOUR:
 A-BLACK
 E-YELLOW

REV.	REVISION RECORD	DATE		GENERAL TOLERANCES		SCALE: 1:1	NAME	DATE	PART.NO: WLR4F9-081XXX037	DWG.NO: ENDE05	 WanLian Technology Co., Ltd
A0	NEW RELEASE	21.01.13		LINEAR	ANGLES	APPROVED	Wang_jr	21.01.13			
A1	ADD $\phi 3.20 \Delta$	23.12.04	UNIT:mm	0.00 ± 0.25	$X^{\circ} \pm 3^{\circ}$	DESIGNER	Han_Gao	21.01.13	TITLE: RJ45 8P8C DIP	REV: A1	
			SIZE: A4	0.000 ± 0.10	$X^{\circ} X^{\circ} \pm 2^{\circ}$	DRAWN	Zijun_Huang	21.01.13			